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ocket No.: 3811-0142PUS1

Page 1 of 1



RECOR

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
 [FAMILY NAME (ALL CAPS), Given Name]
SHIN, Hyeon Jin
JEONG, Hyun Dam
SEON, Jong Back
LEE, Kwang Hee
MAH, Sang Kook

2. Name and address of receiving party(ies)
 Name: **SAMSUNG ELECTRONICS CO., LTD.**
 Internal Address:
 Street Address: **416, Maetan-Dong, Yeongtong-Gu, Suwon-Si**
 City: **Gyeonggi-Do** State: ZIP:
 Country: **KOREA** Postal Code:

Additional name(s) of conveying party(ies) attached?
 YES NO

Additional name(s) & address(es) attached? YES NO

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other:

Execution Date: **May 13, 2004; May 21, 2004; May 21, 2004; May 21, 2004 and May 13, 2004, respectively**

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No(s).
10/841,53

B. Patent No.(s).

Additional numbers attached? YES NO

5. Name and address of party to whom correspondence concerning document should be mailed:
 Name: **BIRCH, STEWART, KOLASCH & BIRCH, LLP**
 Street Address: **P.O. BOX 747**
 City: **FALLS CHURCH** State: **VA** ZIP: **22040-0747**
 Country: **USA**

6. Total No. of applications/patents involved: **One (1)**

7. Total fee (37 C.F.R. § 3.41): **\$40.00**

Enclosed

Authorized to be charged to deposit account, if no fee attached.

8. Deposit account number: **02-2448**

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Joseph A. Kolasch, #22,463
 Name of Person Signing/Reg. No.

Signature

August 2, 2004
 Date

Total number of pages including cover sheet, attachments, and document: **Three (3)**

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 (Rev. 06/23/2004)

PATENT
REEL: 015640 FRAME: 0844

BIRCH, STEWART, KOLASCH & BIRCH, LLPUNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS**ASSIGNMENT**Application No. 10/841,553Filed May 10, 2004Insert Name(s)
of Inventor(s)*****(Given Name FAMILY NAME (ALL CAPS))*****WHEREAS, Hyeon Jin SHINHyun Dam JEONGJong Back SEONKwang Hee LEESang Kook MAH

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in

Insert Title
of Invention**MULTI-FUNCTIONAL CYCLIC SILICATE COMPOUND, SILOXANE-BASED POLYMER
PREPARED FROM THE COMPOUND AND PROCESS OF PRODUCING INSULATING FILM USING
THE POLYMER**

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application).

Insert Date
of Signing of
Applicationon May 13, 2004; May 21, 2004; May 21, 2004; May 21, 2004 and May 13, 2004, and
respectivelyInsert Name
of AssigneeWHEREAS, SAMSUNG ELECTRONICS CO., LTD.Insert Address
of Assigneeof 416,MAETAN-DONG, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO, REPUBLIC OF KOREA

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

 in any foreign countries.**CHECK BOX**
IF APPROPRIATE

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 2004.5.13

Name of Inventor *jin*
(signature) Hyeon Jin SHIN

Date 2004.5.21

Name of Inventor *MDK*
(signature) Hyun Dam JEONG

Date 2004.5.21

Name of Inventor *[Signature]*
(signature) Jong Back SEON

Date 2004.5.21

Name of Inventor *[Signature]*
(signature) Kwang Hee LEE

Date 2004.5.13

Name of Inventor *[Signature]*
(signature) Sang Kook MAH

Date _____

Name of Inventor _____
(signature)